



PDS3100

3A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER POWERDI[®]

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Reverse Leakage Current
- Low Forward Voltage Drop
- High Forward Surge Current Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.093 grams (approximate)



POWERDI5

Top View

Bottom View

LEFT F	PIN (°►°	BOTTOMSIDE
RIGHT F	PIN (HEAT SINK
Note: F	Pins I	Left & Right mu	st

Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 4)

Part Number	Case	Packaging
PDS3100-13	POWERDI5	5000/Tape & Reel
PDS3100-7	POWERDI5	1500/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information

Notes:



S3100 = Product type marking code DIII = Manufacturers' code marking YYWW = Date code marking YY = Last digit of year (ex: 04 for 2004) WW = Week code (01 - 53) K = Factory designator



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

For capacitance load, derate current by 20%.			
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V
RMS Reverse Voltage	V _{R(RMS)}	70	V
Average Rectified Output Current (see also Figure 5)	lo	3	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	90	А

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	_	6.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) $T_A = +25^{\circ}C$	R _{0JA}	95		°C/W
Thermal Resistance Junction to Ambient Air (Note 6) $T_A = +25^{\circ}C$	$R_{ ext{ heta}JA}$	70	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 7) $T_A = +25^{\circ}C$	$R_{\theta JA}$	50		°C/W
Operating Temperature Range	TJ	-65 to	+150	°C
Storage Temperature Range	T _{STG}	-65 to	+175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V _{(BR)R}	100	_	—	V	I _R = 0.2mA
			0.71	0.76	V	$I_F = 3A, T_J = +25^{\circ}C$
			0.61	0.65		$I_F = 3A, T_J = +100^{\circ}C$
Forward Voltage	14		0.57	0.61		I _F = 3A, T _J = +125°C
Forward voltage	VF		0.78	0.84		I _F = 6A, T _J = +25°C
			0.68	0.75		$I_F = 6A, T_J = +100^{\circ}C$
			0.64	0.68		I _F = 6A, T _J = +125°C
			2	100	μΑ	$T_J = +25^{\circ}C, V_R = 100V$
Reverse Current (Note 8)	I _R		0.4	5	mA	$T_J = +100^{\circ}C, V_R = 100V$
			2	20	mA	$T_J = +125^{\circ}C, V_R = 100V$

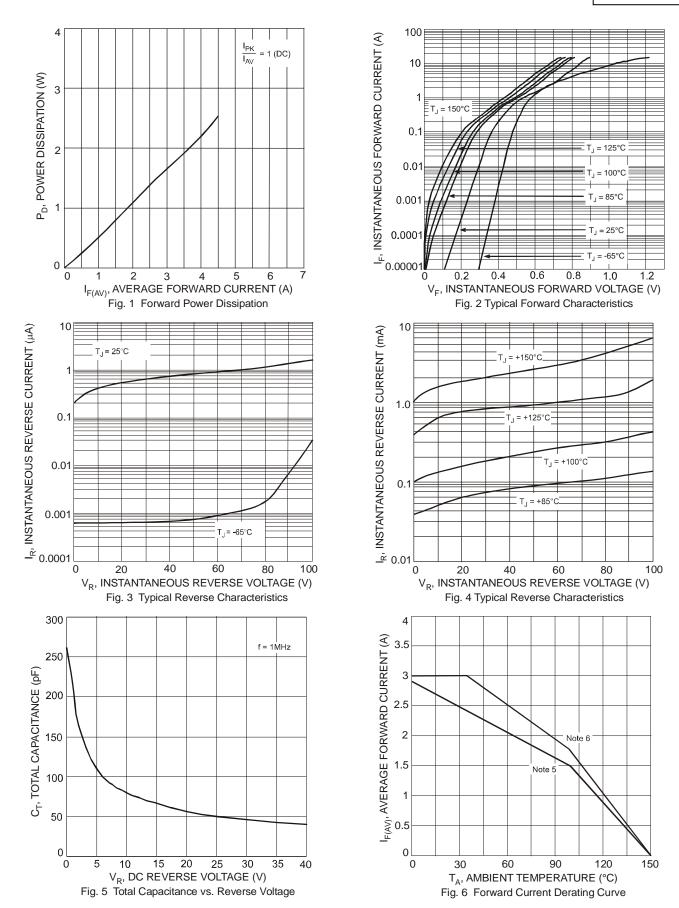
Notes:

5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.

Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.

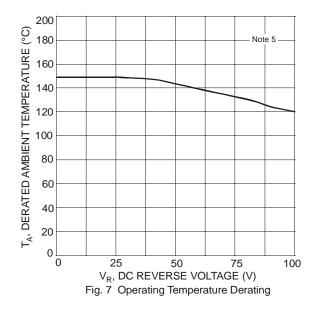
8. Short duration pulse test used to minimize self-heating effect.





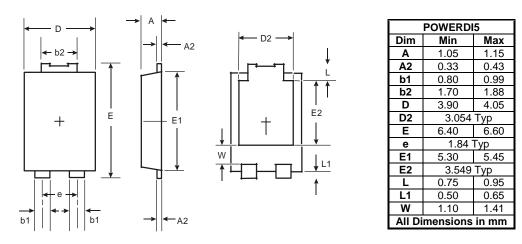
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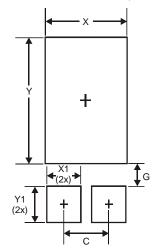
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400



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